LNJ811R88RA

Hight Bright Surface Mounting Chip LED

3216 Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	50	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	100	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

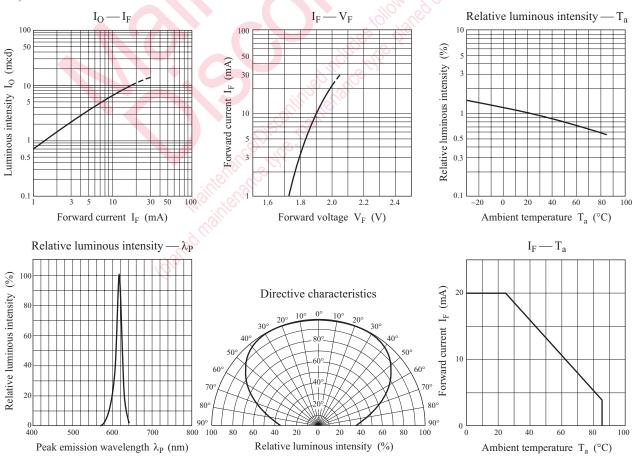
Lighting Color

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

1 u						
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_{\rm F} = 10 {\rm mA}$	3.5	6.5	ço,	med
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_{\rm F} = 10 {\rm mA}$	dur,	1.9	2.5	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F}$ = 10 mA	1 all	620		nm
Spectral half band width	Δλ	$I_{\rm F} = 10 \mathrm{mA}$	OUI	17		nm

Note) *: Measurement tolerance: ±20%

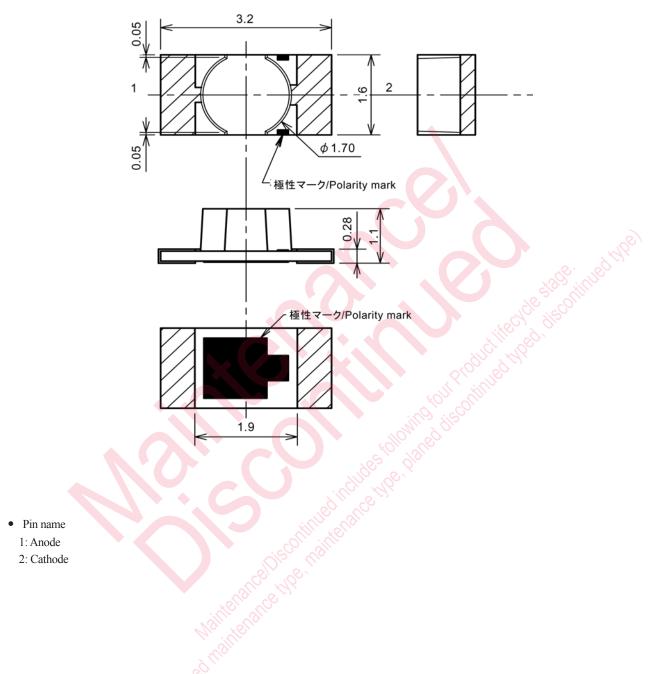


[•] Orange

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Package (Unit: mm)

KLTFTN2K1100



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